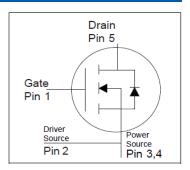


# MDC\_IPL65R230C7\_PS

# PSpice Model NMOS Infineon IPL65R230C7



ThinPAK 8x8



# **Model Information**

Model Call Name	A macro model based on BSIM3 model MDC_IPL65R230C7_PS		
Pin Assign	1:G 2:S 3:S 4:S 5:D		
File List	Model Library	MDC_IPL65R230C7_PS01.lib	
	Model Report	MDC_IPL65R230C7_PS.pdf (this file)	

Verified Simulator Version Note

PSpice version 17.2

#### References

The information which was used for modeling is as follow:

[Data Sheet]
Date/Version
Product name
Company name
Characteristics

Rev. 2.0, 2013-04-29 IPL65R230C7 Infineon Technologies AG IdVds[Vgs],IdVds[Vgs]2,Rds(on)Id[Vgs],Rds(on)Temp[Id],IdV gs[Temp],VgsQg[Vdd],IsVsd[Temp],BvTemp[ir],Capacitance Vds[Cname],SwitchingIdd[Tname],Trrlf[Ir],Qrrlf[Ir],Switching Waveform,TrrWaveform

#### **Simulation Range**

This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

Item	Range		Unit	
	Min.		Max.	
Drain-source voltage (DC)	0	to	650	V
Gate-source voltage (DC)	-20	to	20	V
Temperature	-40	to	150	deg C



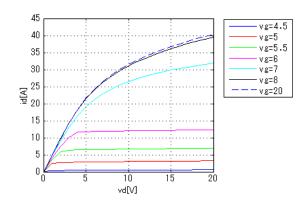
MOSFET		O : Implemented × : Not Implemented — : Not applicable	
Model Functions Table	RANK=1		
Functions	RANK	Implemented	
ID-VDS-VGS	1	0	
ID-VGS(Temp)	1	0	
RDS(on)	1	0	
Capacitance	1	0	
Gate Charge	1	0	
IS-VSD(Forward)	1	0	
Reverse recovery	1	0	
Switching(Typ.)	1	0	
Bv	1	0	
Yfs	1	—	
Vth	1	—	



#### Simulation results are following. Explanatory notes — : simulated

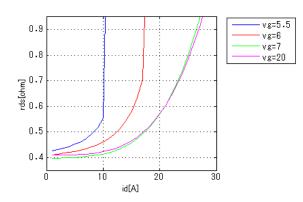
# ldVds[Vgs]

Temp = 25degC



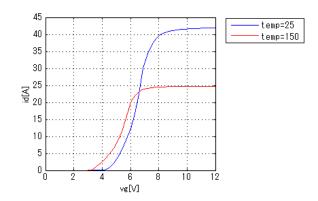
## Rds(on)Id[Vgs]

Temp = 125degC



# ldVgs[Temp]

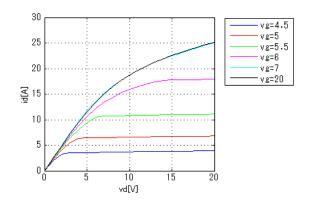
Vds = 20V



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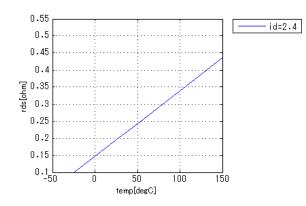
# ldVds[Vgs]2

Temp = 125degC



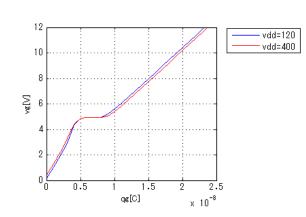
# Rds(on)Temp[ld]

Vgs = 10V



VgsQg[Vdd]

ld = 2.4A



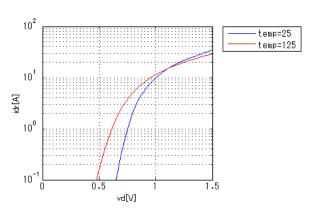
February 24, 2023 Rev. 1.0



#### Simulation results are following. Explanatory notes — : simulated

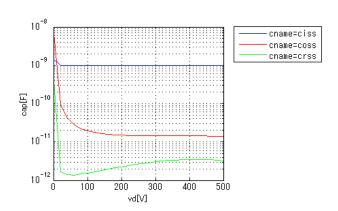
### IsVsd[Temp]





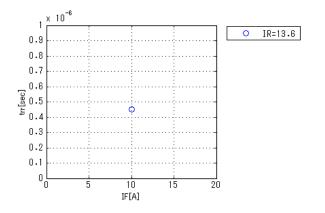
# CapacitanceVds[Cname]

freq = 250000Hz



# Trrlf[lr]

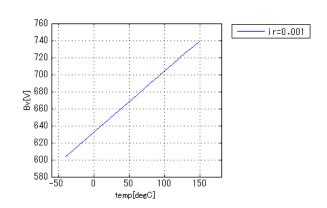
vdd = 400V, didt = 55A/us, Temp = 25degC



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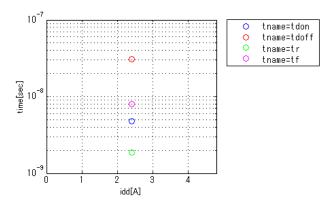
# BvTemp[ir]

ir = 0.001A



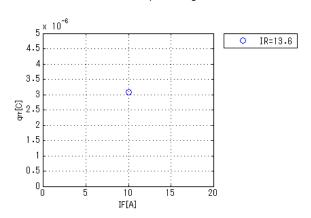
## SwitchingIdd[Tname]

vgg = 13V, vdd = 400V, RGG = 10ohm



# Qrrlf[lr]

vdd = 400V, didt = 55A/us, Temp = 25degC

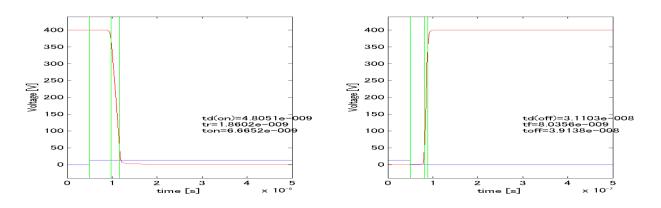




Simulation results are following. Explanatory notes — : simulated

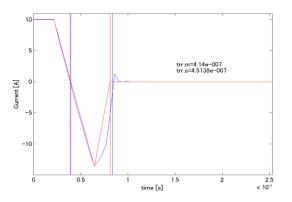
### Switching Waveform ( Blue : INPUT Red : OUTPUT )

 $vgg = 13V, \, vdd = 400V, \, RGG = 10ohm, \, \, idd = 2.4A$ 



## Trr Waveform ( Red : Datasheet Blue : Simulation )

vdd = 400V, didt = 55A/us, Temp = 25degC, If = 10A, Ir = 13.6A





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